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HIGH-PERFORMANCE, INTEGRATED 64-BIT MULTIPROCESSOR SUMMARY OF BENEFITS

FEATURES

- Two scalable 64-bit MIPS CPUs
- 600 MHz-1 GHz
- Quad-issue in order pipeline; dual execute, dual memory pipes
- Enhanced skew pipeline enables zero load-to-use penalty 32-KB instruction cache, 32-KB data cache
- Advanced branch predictors

- Fast, on-chip multiprocessor bus
 Connects the CPUs, L2 cache, memory controller and I/O bridges Runs at half the CPU core frequency; 256 bits wide
- On-chip L2 cache
- 512 KB, shared by both CPUs
- 4-way associative, ECC protected
- Ways can be removed to provide fast on-chip RAM

DDR memory controller

- wo channels, each with a 64-bit data bus plus optional ECC
- Runs up to 200 MHz clock rate, 400 MHz data rate
- Support for DDR SDRAM, SGRAM, and FCRAM

- High-speed packet interfaces
 Three 10/100/1000 Ethernet MACs; 802.3 compliant
 Option to configure MACs into packet FIFOs
- Up to two packet FIFOs each capable of OC-48 data rates

PCI interface

- 32 bits, 33/66 MHz (PCI 2.2)
- Host bridge or target device
- HyperTransport[™] (formerly LDT) I/O interface
 Complies with HyperTransport[™] standard for high-speed I/O fabric
 500-MHz clock rate, double data rate, for 600 MHz CPUs; 600-MHz clock rate for 800 MHz CPUs
 - Peak bandwidth of 9.6 Gbps in each direction @ 600 MHz
 - Supports double-ended fabrics (to link two BCM1250s)

- Integrated system I/O Generic I/O for direct connect to boot ROM, flash
 - Two SMBus serial configuration interfaces
- PCMCIA control interface
- Two serial interfaces
- Extensive, on-chip debug features

8-10W power dissipation @ 800 MHz

- Support for leading operating systems including VxWorks[®], Linux[®] and NetBSD
- Evaluation board platform available with tools, firmware and software drivers

Packet Processing Blade

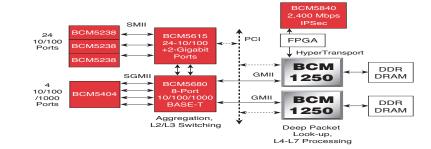
Industry-leading performance

- Processing speed of up to 10 Mpps*
- 128 Gbps on-chip bus bandwidth; 50 Gbps memory bandwidth, 30 Gbps total I/O bandwidth
- Low power dissipation of 8-10W (@ 800 MHz)
- High functional integration
- Programming ease and flexibility based on MIPS64 Instruction Set Architecture (ISA)
- Scalable multiprocessor chip and system architecture
- Broad tools and system software support •
- For additional information on the BCM1250 evaluation boards, refer to the BCM91250A and BCM91250E product briefs

*Based on internal Broadcom benchmark, using BCM1250 for standard IPv4 L3 look-up/switching.

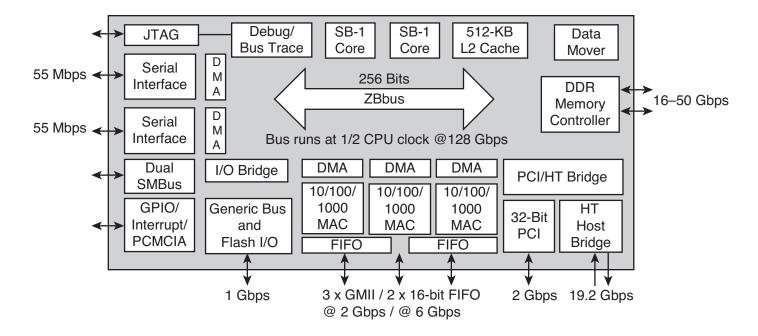
APPLICATIONS

- Due to the BCM1250's world-class performance, power efficiency and integration, the processor is ideal for a broad variety of applications including:
 - · Enterprise workgroup and backbone switches
 - VPN switches/routers
 - · Multiservice access concentrators
 - · SAN routers/gateway/switches
 - · IP services/subscriber management platforms
 - Web-server switches
 - · High-end firewall/intrusion detection devices
 - Wireless basestations



BROADCOM

OVERVIEW



Broadcom's first SiByteTM processor, the **BCM1250**, is a state-of-the-art multiprocessor solution targeted at the fast-growing networking and communications markets.

The **BCM1250** is the first MIPS64TM processor to offer the industryleading performance, high functional integration, and low power levels required by next-generation networking applications.

The **BCM1250** is an intelligent on-chip multiprocessor system (CMP) consisting of two Broadcom SB-1 high performance MIPS64TM CPUs, a shared 512-KB L2 cache, a DDR memory controller, and integrated I/O. All major blocks of the processor are connected together via the ZBbus, a high-speed, split-transaction multiprocessor bus. The bus implements the standard MESI protocol to ensure coherency between the two CPUs, L2 cache, I/O agents, and memory.

Three Gigabit Ethernet MACs (10/100/1000) enable easy interfacing to LANs. To enable higher data rates, or in cases where Ethernet protocol processing is not required, the MACs can be configured as either three 8-bit or two 16-bit packet FIFOs. The high-speed I/O is provided using HyperTransportTM (HT) I/O fabric and a 32-bit PCI (rev 2.2) local bus. Two serial ports are available to use as UARTs for console ports or

asynchronous interface for WAN connections at up to T3/OC-1 rates (55 Mbps).

To enable low chip-count systems, the **BCM1250** also includes a configurable generic bus that allows glueless connection of a boot ROM or flash memory and simple I/O peripherals. On-chip debug, trace, and performance monitoring functions assist both hardware and software designers in debugging and tuning the system. The system can be run in either big- or little-endian mode. The **BCM1250** is manufactured in TSMC's 0.13μ process and is available in an 860 BGA package.

Implementation of MIPS64TM ISA

The SB-1 CPU core is a high-performance implementation of the standard MIPS64TM instruction set architecture (ISA), and incorporates the MIPS-3D and MIPS-MDMX application specific extensions (ASEs).

The core supports a four-issue enhanced skew pipeline and can dispatch up to two memory and two ALU (Integer, Floating Point, MDMX or MIPS-3D) instructions per cycle.

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